

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT3106708

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
PAUL A. NYGAARD	11/12/2014
STUART B. MOLIN	11/12/2014
MICHAEL A. STUBER	11/12/2014
MAX AUBAIN	11/10/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SILANNA SEMICONDUCTOR U.S.A., INC.
<b>Street Address:</b>	4350 EXECUTIVE DRIVE, SUITE 200
<b>City:</b>	SAN DIEGO
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	92121
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14540268
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(858)794-1496
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	8584811883
<b>Email:</b>	eric@themuellerlawoffice.com
<b>Correspondent Name:</b>	HEATHER MUELLER
<b>Address Line 1:</b>	THE MUELLER LAW OFFICE, P.C.
<b>Address Line 2:</b>	12707 HIGH BLUFF DRIVE, SUITE 200
<b>Address Line 4:</b>	SAN DIEGO, CALIFORNIA 92130
<b>ATTORNEY DOCKET NUMBER:</b>	IOSEP002CIP1
<b>NAME OF SUBMITTER:</b>	ERIC R. SCHEUERLEIN
<b>SIGNATURE:</b>	/Eric R. Scheuerlein/
<b>DATE SIGNED:</b>	11/13/2014
<b>Total Attachments: 3</b>	
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source=20141113_IOSEP002CIP1_assign#page2.tif	



**ASSIGNMENT**

For good and valuable consideration, we, **Paul A. Nygaard**, residing in Carlsbad, CA; **Stuart B. Molin**, residing in Carlsbad, CA; **Michael A. Stuber**, residing in Rancho Santa Fe, CA; and **Max Aubain**, residing in San Diego, CA,

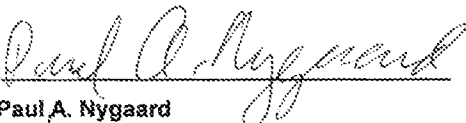
Hereby sell, assign and transfer to **SILANNA SEMICONDUCTOR U.S.A., INC.**, having a principal place of business at **4350 Executive Drive, Suite 200, San Diego, CA 92121**, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for a United States Patent being filed herewith and entitled:

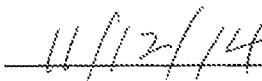
**SEMICONDUCTOR-ON-INSULATOR WITH BACK SIDE STRAIN TOPOLOGY**

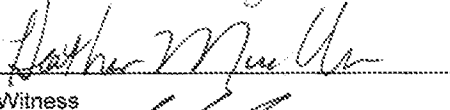
and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

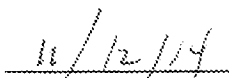
Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

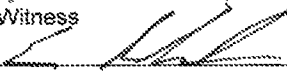
Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

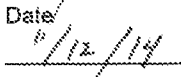
  
Paul A. Nygaard


  
Date 11/12/14

  
Witness

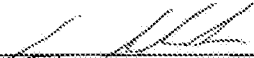
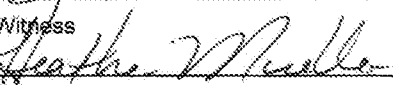
  
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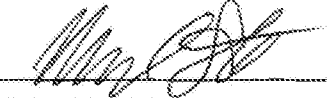
  
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Stuart B. Molin


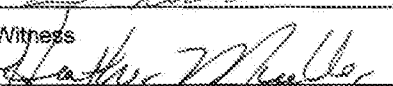
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Michael A. Stuber

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Max Aubain  
  
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**Stuart B. Molin**

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**Michael A. Stuber**

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**Date**

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/Max Aubain/

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11/10/14

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**Max Aubain**

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**Date**

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